

Octal-Bus Transceiver/Registers, 3-State

SCHS294

B3 DATA CD54/74AC/ACT651 - Inverting B4 PORT CD54/74AC/ACT652 - Non-Inverting

> Type Features: Buffered inputs

Typical propagation delay:
 5.3 ns @ Vcc = 5 V, T<sub>A</sub> = 25° C, C<sub>L</sub> = 50 pF

The RCA CD54/74AC651 and CD54/74AC652 and the CD54/74ACT651 and CD54/74ACT652 3-state, octal-bus transceiver/registers use the RCA ADVANCED CMOS technology. The CD54/74AC651 and CD54/74ACT651 have inverting outputs. The CD54/74AC652 and CD54/74ACT652 have non-inverting outputs. These devices consist of bus transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. Output Enables OEAB and OEBA are provided to control the transceiver functions. SAB and SBA control pins are provided to select whether real-time or stored data is transferred. The circuitry used for select control will eliminate the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. A LOW input level selects real-time data, and a HIGH selects stored data. The following examples demonstrate the four fundamental busmanagement functions that can be performed with the octal-bus transceivers and registers.

Data on the A or B data bus, or both, can be stored in the internal D flip-flops by low-to-high transitions at the appropriate clock pins (CAB or CBA) regardless of the select or enable control pins. When SAB and SBA are in the real-time transfer mode, it is also possible to store data without using the internal D-type flip-flops by simultaneously enabling  $OE_{AB}$  and  $\overline{OE}_{BA}$ . In this configuration, each output reinforces its input. Thus, when all other data sources to the two sets of bus lines are at high impedance, each set of bus lines will remain at its last state.

The CD74AC/ACT651 and CD74AC/ACT652 are supplied in 24-lead dual-in-line narrow-body plastic packages (EN suffix) and in 24-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC/ACT651 and CD54AC/ACT652, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

#### **Family Features:**

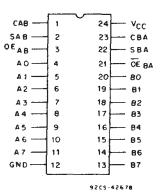
- Exceeds 2-kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design

TEXAS

**INSTRUMENTS** Data sheet acquired from Harris Semiconductor

- Speed of bipolar FAST\*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- ± 24-mA output drive current
  Fanout to 15 FAST\* ICs
  - Drives 50-ohm transmission lines

\*FAST is a Registered Trademark of Fairchild Semiconductor Corp.



#### TERMINAL ASSIGNMENT

This data sheet is applicable to the CD74AC562, CD74ACT651, and CD74ACT652. The CD54/74AC651, CD54AC652, CD54ACT651, and CD54ACT652 were not acquired from Harris Semiconductor. File Number **1974** 

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# CD54/74AC651, CD54/74AC652 CD54/74ACT651, CD54/74ACT652

#### FUNCTION TABLE

|      |                  | INP    | UTS    |     |     | DAT                      | A I/O                    | OPERATION (                | OR FUNCTION               |
|------|------------------|--------|--------|-----|-----|--------------------------|--------------------------|----------------------------|---------------------------|
| OEAB | OE <sub>BA</sub> | CAB    | CBA    | SAB | SBA | A0 THRU A7               | B0 THRU B7               | 651                        | 652                       |
| L    | н                | H or L | H or L | X   | X   | Input                    | Innut                    | Isolation *                | Isolation*                |
| L    | н                |        |        | X   | X   | mput                     | Input                    | Store A and B Data         | Store A and B Data        |
| X    | н                |        | H or L | X   | х   | Input                    | Unspecified <sup>†</sup> | Store A, Hold B            | Store A, Hold B           |
| н    | н                |        |        | x‡  | X   | Input                    | Output                   | Store A in both registers  | Store A in both registers |
| L    | х                | H or L |        | X   | х   | Unspecified <sup>†</sup> | Input                    | Hold A, Store B            | Hold, A Store B           |
| L    | L                |        |        | X   | x‡  | Output                   | Input                    | Store B in both registers  | Store B in both registers |
| L    | L                | X      | X      | X   | L   | <u></u>                  |                          | Real-Time B Data to A Bus  | Real-Time B Data to A Bus |
| L    | L                | X      | H or L | X   | н   | Output                   | Input                    | Stored B Data to A Bus     | Stored B Data to A Bus    |
| н    | H                | X      | Х      | L   | ×   |                          |                          | Real-Time A Data to B Bus  | Real-Time A Data to B Bus |
| н    | H                | H or L | X      | н   | Х   | Input                    | Output                   | Stored A Data to B Bus     | Stored A Data to B Bus    |
| н    | 1                | Horl   | Horl   | ц   | ц   | 0                        | <u></u>                  | Stored A Data to B Bus and | Stored A Data to B Bus    |
|      | L                |        | H or L | н   | н   | Output                   | Output                   | Stored B Data to A bus     | Stored B Data to A Bus    |

\* To prevent excess currents in the High-Z (isolation) modes, all I/O terminals should be terminated with 10kΩ to 1MΩ resistors.

† The data output functions may be enabled or disabled by various signals at the OEAB or OEBA inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every low-to-high transition on the clock inputs.

‡ Select control = L: clocks can occur simultaneously.

Select control = H: clocks must be staggered in order to load both registers.

#### MAXIMUM RATINGS, Absolute-Maximum Values:

| DC SUPPLY-VOLTAGE (V <sub>cc</sub> )<br>DC INPUT DIODE CURRENT, I <sub>ik</sub> (for V <sub>i</sub> < -0.5 V or V <sub>i</sub> > V <sub>cc</sub> + 0.5 V)<br>DC OUTPUT DIODE CURRENT, I <sub>ok</sub> (for V <sub>o</sub> < -0.5 V or V <sub>o</sub> > V <sub>cc</sub> + 0.5 V)<br>DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, I <sub>o</sub> (for V <sub>o</sub> > -0.5 V or V <sub>c</sub><br>DC V <sub>cc</sub> or GROUND CURRENT (I <sub>cc</sub> or I <sub>GND</sub> ) | $\pm 20 \text{ mA}$<br>$\pm 50 \text{ mA}$<br>$h < V_{CC} + 0.5 \text{ V}$ $\pm 50 \text{ mA}$ |
|--|--|
| POWER DISSIPATION PER PACKAGE (Pp):  |  |
| For $T_A = -55$ to $\pm 100^{\circ}$ C (PACKAGE TYPE E)  |  |
| For $T_A = \pm 100$ to $\pm 125^{\circ}$ C (PACKAGE TYPE E)  | Derate Linearly at 8 mW/°C to 300 mW   |
| For $T_A = -55$ to $+70^{\circ}$ C (PACKAGE TYPE M)  |  |
| For $T_A = +70$ to $+125^{\circ}$ C (PACKAGE TYPE M)   | . Derate Linearly at 6 mW/°C to 70 mW  |
| OPERATING-TEMPERATURE RANGE (T <sub>A</sub> )  |  |
| STORAGE TEMPERATURE (T <sub>stg</sub> )  | 65 to +150°C   |
| LEAD TEMPERATURE (DURING SOLDERING):   |  |
| At distance 1/16 $\pm$ 1/32 in. (1.59 $\pm$ 0.79 mm) from case for 10 s maximum  | +265°C   |
| Unit inserted into PC board min. thickness 1/16 in. (1.59 mm) with solder contactir  | ng lead tips only+300°C  |
| *For up to 4 outputs per device; add $\pm$ 25 mA for each additional output.   |  |
|  |  |

#### **RECOMMENDED OPERATING CONDITIONS:**

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTICS                                       | LIN                                   |      |       |  |
|---|---------------------------------------|------|-------|--|
| CHARACTERISTICS                                       | MIN.                                  | MAX. | UNITS |  |
| Supply-Voltage Range, Vcc*:                           | · · · · · · · · · · · · · · · · · · · |      |       |  |
| (For T <sub>A</sub> = Full Package-Temperature Range) |                                       |      |       |  |
| AC Types  | 1.5                                   | 5.5  | V     |  |
| ACT Types   | 4.5                                   | 5.5  | V     |  |
| DC Input or Output Voltage, VI, Vo                    | 0                                     | Vcc  | V     |  |
| Operating Temperature, TA                             | -55                                   | +125 | °C    |  |
| Input Rise and Fall Slew Rate, dt/dv                  |                                       |      |       |  |
| at 1.5 V to 3 V (AC Types)                            | 0                                     | 50   | ns/V  |  |
| at 3.6 V to 5.5 V (AC Types)                          | 0                                     | 20   | ns/V  |  |
| at 4.5 V to 5.5 V (ACT Types)                         | 0                                     | 10   | ns/V  |  |

\*Unless otherwise specified, all voltages are referenced to ground.

STATIC ELECTRICAL CHARACTERISTICS: AC Series

| •                                     |                 |   |                        |                 | AMBIEN             | Т ТЕМРЕ            | RATURE             | E (T <sub>A</sub> ) - ° ( | С .                | ]                  |       |
|---------------------------------------|-----------------|---|------------------------|-----------------|--------------------|--------------------|--------------------|---------------------------|--------------------|--------------------|-------|
| CHARACTERIST                          | CS              | TEST CO                                     | NDITIONS               | V <sub>cc</sub> | +                  | 25                 | -40't              | o +85                     | -55 to             | o +125             | UNITS |
|                                       |                 | V,<br>(V).                                  | l <sub>o</sub><br>(mA) | (V)             | MIN.               | MAX.               | MIN.               | MAX.                      | MIN.               | MAX.               |       |
| High-Level Input<br>Voltage           | VIH             |   |                        | 1.5<br>3<br>5.5 | 1.2<br>2.1<br>3.85 | -                  | 1.2<br>2.1<br>3.85 |                           | 1.2<br>2.1<br>3.85 | -                  | v     |
| Low-Level Input<br>Voltage            | Vil             |   |                        | 1.5<br>3<br>5.5 |                    | 0.3<br>0.9<br>1.65 |                    | 0.3<br>0.9<br>1.65        | -                  | 0.3<br>0.9<br>1.65 | v     |
| High-Level Output                     |                 |   | -0.05                  | 1.5             | 1.4                |                    | 1.4                |                           | 1.4                | -                  | 1     |
| Voltage                               | V <sub>OH</sub> | V <sub>IH</sub>                             | -0.05                  | 3               | 2.9                | -                  | 2.9                |                           | 2.9                | -                  | ]     |
| ,                                     |                 | or  | -0.05                  | 4.5             | 4.4                |                    | 4.4                |                           | 4.4                | ·                  | ]     |
|                                       |                 | ViL   | -4                     | 3               | 2.58               |                    | 2.48               | -                         | 2.4                |                    | ] v   |
|                                       |                 |   | -24                    | 4.5             | 3.94               | _                  | 3.8                |                           | 3.7                |                    |       |
|                                       |                 | #, * {                                      | -75                    | 5.5             |                    |                    | 3.85               |                           |                    |                    | ]     |
|                                       |                 | "" l  | -50                    | 5.5             | _                  | _                  |                    | -                         | 3.85               |                    | ]     |
| Low-Level Output                      |                 |   | 0.05                   | 1.5             | -                  | 0.1                | -                  | 0.1                       | -                  | 0.1                |       |
| Voltage                               | Vol             | Vн  | 0.05                   | 3               |                    | 0.1                |                    | 0.1                       |                    | 0.1                | · ·   |
|                                       |                 | or  | 0.05                   | 4.5             |                    | 0.1                |                    | 0.1                       |                    | 0.1                |       |
|                                       |                 | ViL   | 12                     | 3               |                    | 0.36               |                    | 0.44                      |                    | 0.5                | ) v   |
|                                       |                 |   | 24                     | 4.5             |                    | 0.36               |                    | 0.44                      |                    | 0.5                |       |
|                                       |                 | #. * {                                      | 75                     | 5.5             |                    |                    |                    | 1.65                      |                    |                    |       |
| · · · · · · · · · · · · · · · · · · · |                 | <u> </u>                                    | 50                     | 5.5             |                    |                    | ·                  |                           |                    | 1.65               |       |
| Input Leakage<br>Current              | h               | V <sub>cc</sub><br>or<br>GND                |                        | 5.5             |                    | ±0.1               |                    | ±1                        |                    | ±1                 | μA    |
| 3-State<br>Leakage<br>Current         | loz             | ViH<br>or<br>ViL<br>Vo=<br>Vcc<br>or<br>GND |                        | 5.5             |                    | ±0.5               |                    | ±5                        |                    | <u>+</u> 10        | μA    |
| Quiescent Supply<br>Current, MSI      | l <sub>cc</sub> | V <sub>cc</sub><br>or<br>GND                | 0                      | 5.5             |                    | 8                  |                    | 80                        |                    | 160                | μA    |

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

#### \_ Technical Data

# CD54/74AC651, CD54/74AC652 CD54/74ACT651, CD54/74ACT652

#### STATIC ELECTRICAL CHARACTERISTICS: ACT Series

|  |                 |  |                        |                  | AMBIENT TEMPERATURE (TA) - °C |      |       |          |             |          |       |
|--|-----------------|--|------------------------|------------------|-------------------------------|------|-------|----------|-------------|----------|-------|
| CHARACTERISTIC   | s               | TEST CON   | DITIONS                | V <sub>cc</sub>  | +                             | 25   | -40 t | o +85    | -55 to +125 |          | UNITS |
|  |                 |  | l <sub>o</sub><br>(mA) | (V)              | MIN.                          | MAX. | MIN.  | MAX.     | MIN.        | MAX.     |       |
| High-Level Input<br>Voltage  | Vін             |  |                        | 4.5<br>to<br>5.5 | 2                             | -    | 2     | ·        | 2           | -        | v     |
| Low-Level Input<br>Voltage   | Vil             |  |                        | 4.5<br>to<br>5.5 |                               | 0.8  |       | 0.8      | _           | 0.8      | v     |
| High-Level Output  |                 | ViH  | -0.05                  | 4.5              | 4.4                           | _    | 4.4   |          | 4.4         |          | Î     |
| Voltage  | Vон             | or<br>Vit  | -24                    | 4.5              | 3.94                          |      | 3.8   | <u> </u> | 3.7         | <u> </u> | ]     |
|  |                 | #, * {   | -75                    | 5.5              |                               | -    | 3.85  |          | _           |          | 1 V   |
|  |                 | <u>"' (</u>  | -50                    | 5.5              |                               |      |       |          | 3.85        |          | 1     |
| Low-Level Output   |                 | Vін  | 0.05                   | 4.5              | —                             | 0.1  |       | 0.1      | - 1         | 0.1      |       |
| Voltage  | Vol             | or<br>Vı∟  | 24                     | 4.5              | _                             | 0.36 |       | 0.44     |             | 0.5      | 1 v   |
|  |                 | #, * {   | 75                     | 5.5              | _                             |      |       | 1.65     | _           | <u> </u> |       |
|  |                 | <b>"</b> , " {   | 50                     | 5.5              | -                             |      |       |          | -           | 1.65     | 1     |
| Input Leakage<br>Current   | ħ               | V <sub>cc</sub><br>or<br>GND   |                        | 5.5              | —                             | ±0.1 | _     | ±1       | _           | ±1       | μΑ    |
| 3-State<br>Leakage<br>Current  | l <sub>oz</sub> | V <sub>IH</sub><br>or<br>V <sub>IL</sub><br>V <sub>0</sub> =<br>V <sub>CC</sub><br>or<br>GND |                        | 5.5              |                               | ±0.5 | _     | ±5       | _           | ±10      | μΑ    |
| Quiescent Supply<br>Current, MSI   | łcc             | V <sub>cc</sub><br>or<br>GND   | 0                      | 5.5              |                               | 8    | _     | 80       | _           | 160      | μA    |
| Additional Quiescent Si<br>Current per Input Pin<br>TTL Inputs High<br>1 Unit Load |                 | V <sub>cc</sub> -2.1   |                        | 4.5<br>to<br>5.5 |                               | 2.4  |       | 2.8      |             | 3        | mA    |

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation. \* Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

| INPUT    | UNIT LOAD* |
|----------|------------|
| CAB, CBA | 1.25       |
| SAB, SBA | 1.2        |
| OEAB     | 0.67       |
| ŌĒBA     | 1.17       |
| An, Bn   | 0.4        |
|          |            |

#### ACT INPUT LOADING TABLE

\*Unit load is  $\Delta I_{CC}$  limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

PREREQUISITE FOR SWITCHING: AC Series

|                              |                  |                        | AMBI             | `) - °C |                  |       |     |  |
|------------------------------|------------------|------------------------|------------------|---------|------------------|-------|-----|--|
| CHARACTERISTICS              | SYMBOL           | V <sub>cc</sub><br>(V) | -40 1            | o +85   | -55 to           | UNITS |     |  |
|                              |                  | (•)                    | MIN.             | MAX.    | MIN.             | MAX.  | ].  |  |
| Max. Frequency               | f <sub>max</sub> | 1.5<br>3.3*<br>5†      | 11<br>101<br>143 |         | 10<br>89<br>125  | <br>  | MHz |  |
| Setup Time<br>Data to Clock  | tsu              | 1.5<br>3.3<br>5        | 27<br>3.1<br>2.2 | -       | 31<br>3.5<br>2.5 |       | ns  |  |
| Hold Time<br>Data to Clock   | t <sub>H</sub>   | 1.5<br>3.3<br>5        | 2<br>2<br>2      | -       | 2<br>2<br>2      |       | ns  |  |
| Clock Pulse<br>Data to Clock | tw               | 1.5<br>3.3<br>5        | 44<br>4.9<br>3.5 |         | 50<br>5.6<br>4   |       | ns  |  |

\*3.3 V: min. is @ 3 V

†5 V; min. is @ 4.5 V

#### SWITCHING CHARACTERISTICS: AC Series; t, t = 3 ns, CL = 50 pF

|  | 1 1              |                 | AMBI     | 1                    |          |        |          |
|--|------------------|-----------------|----------|----------------------|----------|--------|----------|
| CHARACTERISTICS                        | SYMBOL           | V <sub>cc</sub> | -40 1    | o +85                | -55 t    | o +125 |          |
| ······································ |                  | (V)             | MIN.     | MAX.                 | MIN.     | MAX.   |          |
| Propagation Delays:                    |                  |                 |          |                      | <u> </u> |        |          |
| Store A Data to B Bus                  | t <sub>PLH</sub> | 1.5             | -        | 154                  | -        | 169    |          |
| Store B Data to A Bus                  | тен              | 3.3*            | 4.8      | 17.1                 | 4.7      | 18.9   | ns       |
| 652                                    | (PHL             | 5†              | 3.5      | 12.3                 | 3.4      | 13.5   |          |
| Store A Data to B Bus                  |                  | 1.5             | _        | 154                  |          | 169    | T        |
| Store B Data to A Bus                  | Трін             | 3.3             | 4.8      | 17.1                 | 4.7      | 18.9   | ns       |
| 651                                    | Трис             | 5               | 3.5      | 12.3                 | 3.4      | 13.5   |          |
| A Data to B Bus                        |                  | 1.5             |          | 125                  |          | 138    | 1        |
| B Data to A Bus                        | t <sub>PLH</sub> | 3.3             | 4        | 14                   | 3.9      | 15.4   | ns       |
| 652                                    | t <sub>PHL</sub> | 5               | 2.8      | 10                   | 2.8      | 11     |          |
| A Data to B Bus                        |                  | 1.5             |          | 125                  |          | 138    | f        |
| B Data to A Bus                        | t <sub>PLH</sub> | 3.3             | 4        | 14                   | 3.9      | 15.4   | ns       |
| 651                                    | 1 <sub>PHL</sub> | 5               | 2.8      | 10                   | 2.8      | 11     |          |
| Select to Data                         |                  | 1.5             |          | 136                  |          | 150    | <u> </u> |
| 652                                    | . telh           | 3.3             | 4.3      | 15.3                 | 4.2      | 16.8   | ns       |
| 032                                    | t <sub>PHL</sub> | 5               | 3.1      | 10.9                 | 3        | 12     |          |
| Select to Data                         |                  | 1.5             |          | 136                  |          | 150    |          |
| 651                                    | t <sub>PLH</sub> | 3.3             | 4.3      | 15.3                 | 4.2      | 16.8   | ns       |
| 001                                    | t <sub>PHL</sub> | 5               | 3.1      | 10.9                 | 3        | 12     |          |
| 3-State Enabling/                      | tezu             |                 |          |                      |          | 1      |          |
| Disabling Time                         | tezh             | 1.5             |          | 154                  | —        | 169    | 1        |
| Bus to Output or                       | terz             | 3.3             | 5.2      | 18.4                 | 5.1      | 20.2   | ns       |
| Register to Output                     | t <sub>PHZ</sub> | 5               | 3.5      | 12.3                 | 3.4      | 13.5   | 1        |
| Power Dissipation Capacitance          | CPD§             |                 | 150      | Тур.                 | 150      | Тур.   | pF       |
|  | он               |                 |          |                      | I        |        | <u> </u> |
| During Switching of                    | VOHV             |                 |          |                      |          |        |          |
| Other Outputs (Output                  | See              | 5               |          | 4 Typ. (             | @ 25° C  |        | V I      |
| Under Test Not                         | Fig. 1           |                 | ĺ        |                      |          |        |          |
| Switching)                             |                  |                 |          |                      |          |        |          |
|  | OL               |                 | <u> </u> | * <u>*** * = =</u> * |          |        | t        |
| During Switching of                    | VOLP             |                 |          |                      |          |        |          |
| Other Outputs (Output                  | See              | 5               | [        | 1 Typ. (             | @ 25° C  |        | ( V      |
| Under Test Not                         | Fig. 1           |                 |          |                      |          |        |          |
| Switching)                             |                  |                 | 1        |                      |          |        |          |
| Input Capacitance                      | Ĉ,               |                 |          | 10                   | _        | 10     | pF       |
| 3-State Output Capacitance             | Co               |                 |          | 15                   |          | 15     | pF       |

max. is @ 3 V

15 V: min. is @ 5.5 V

max. is @ 4.5 V

 $P_D = V_{CC}^{-2} \, C_{PD} \, f_i + \Sigma \, (V_{CC}^{-2} C_L f_o)$  where  $|f_i| = input$  frequency

 $f_o =$  output frequency  $C_L =$  output load capacitance

Vcc - supply voltage.

#### \_ Technical Data

# CD54/74AC651, CD54/74AC652 CD54/74ACT651, CD54/74ACT652

#### **PREREQUISITE FOR SWITCHING: ACT Series**

|                             |                |                        | AMBI  |       |        |       |     |  |
|-----------------------------|----------------|------------------------|-------|-------|--------|-------|-----|--|
| CHARACTERISTICS             | SYMBOL         | V <sub>cc</sub><br>(V) | -40 t | o +85 | -55 to | UNITS |     |  |
|                             |                | (*)                    | MIN.  | MAX.  | MIN.   | MAX.  | 1   |  |
| Max. Frequency              | fmax           | 5*                     | 125   |       | 110    | _     | MHz |  |
| Setup Time<br>Data to Clock | tsu            | 5                      | 2.2   |       | 2.5    | -     | ns  |  |
| Hold Time<br>Data to Clock  | t <sub>H</sub> | 5                      | 2     | -     | 2      | -     | ns  |  |
| Clock Pulse<br>Width        | tw             | 5                      | 3.9   | -     | 4.5    | —     | ns  |  |

\*5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: ACT Series; t,, tr = 3 ns, CL = 50 pF

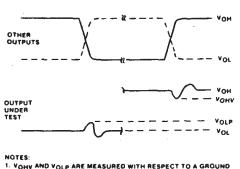
|   |                                      |                 | AMBI          | ENT TEMP  | ERATURE ( | T <sub>A</sub> ) - <sup>°</sup> °C |    |
|---|--------------------------------------|-----------------|---------------|-----------|-----------|------------------------------------|----|
| CHARACTERISTICS   | SYMBOL                               | V <sub>cc</sub> |               | lo +85    | 1         | o +125                             |    |
|   |                                      | (V)             | MIN.          | MIN. MAX. |           | MIN. MAX.                          |    |
| Propagation Delays:<br>Store A Data to B Bus<br>Store B Data to A Bus<br>652                    | t <sub>РLH</sub><br>t <sub>PHL</sub> | 5*              | 4             | 14.1      | 3.9       | 15.5                               | ns |
| Store Ā Data to B Bus<br>Store B Data to A Bus<br>651   | t <sub>РLН</sub><br>t <sub>РНL</sub> | 5               | 4             | 14.1      | 3.9       | 15.5                               | ns |
| A Data to B Bus<br>B Data to A Bus<br>652   | tein<br>teni                         | 5               | 3.2           | 11.4      | 3.1       | 12.5                               | ns |
| Ā Data to B Bus<br>B Data to A Bus<br>651   | tрін<br>tphl                         | 5               | 3.2           | 11.4      | 3.1       | 12.5                               | ns |
| Select to Data<br>652   | t <sub>РСН</sub><br>tенс             | 5               | 3.7           | 13.2      | 3.6       | 14.5                               | ns |
| Select to Data<br>651   | t <sub>РЕН</sub><br>tрнс             | 5               | 4             | 14.1      | 3.9       | 15.5                               | ns |
| 3-State Enabling/<br>Disabling Time<br>Bus to Output or<br>Register to Output                   | tpzi<br>tpzh<br>tplz<br>tplz<br>tphz | 5               | 4             | 14.1      | 3.9       | 15.5                               | ns |
| Power Dissipation Capacitance   | CPD§                                 | _               | 150           | Тур.      | 150       | Тур.                               | рF |
| Min. (Valley) V<br>During Switching of<br>Other Outputs (Output<br>Under Test Not<br>Switching) | V <sub>он</sub> v<br>See<br>Fig. 1   | 5               | 4 Typ. @ 25°C |           |           |                                    | V  |
| Max. (Peak)<br>During Switching of<br>Other Outputs (Output<br>Under Test Not<br>Switching)     | Vol Vol P<br>See<br>Fig. 1           | 5               |               | v         |           |                                    |    |
| Input Capacitance   | Ci                                   |                 |               | 10        |           | 10                                 | pF |
| 3-State Output Capacitance  | Co                                   | _               |               | 15        | _         | 15                                 | pF |

\*5 V: min. is @ 5.5 V max. is @ 4.5 V §CPD is used to determine the dynamic power consumption, per package.  $P_{D} = V_{Cc}^{2} C_{PD} f_{i} + \Sigma V_{Cc}^{2} C_{L} f_{o} + V_{Cc} \Delta I_{Cc} \text{ where } f_{i} = \text{input frequency}$ 

 $f_0 = output frequency$ 

 $C_L =$  output load capacitance  $V_{cc} =$  supply voltage.

9

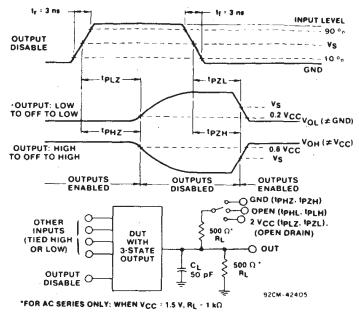


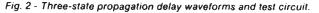
1. VGNV AND VOLP ARE MEASURED WITH RESPECT TO A GROUND REFERENCE NEAR THE OUTPUT UNDER TEST. 2. INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS: PRR -1 MHz, 1- 3 as, 1- 3 as, 5 KEW 1 ns. 3. R.F. FIXTURE WITH 700-MHz DESIGN RULES REQUIRED.

- IC SHOULD BE SOLDERED INTO TEST BOARD AND BYPASED WITH 0.1 # CAPACITOR. SCOPE AND PROBES REQUIRE 700-MH2 BANDWIDTH.



9205-42406





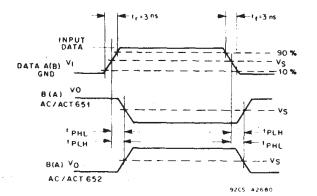
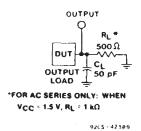


Fig. 3 - Propagation delay times.



|                              | CD54/74AC           | CD54/74ACT |
|------------------------------|---------------------|------------|
| Input Level                  | Vcc                 | 3 V        |
| Input Switching Voltage, Vs  | 0.5 V <sub>cc</sub> | 1.5 V      |
| Output Switching Voltage, Vs | 0.5 V <sub>cc</sub> | 0.5 Vcc    |

Fig. 5 - Test circuit.

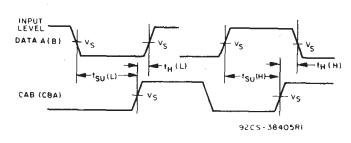


Fig. 4 - Data setup and hold times.



#### PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------------|--------------------|--------------|-------------------------|---------|
|                  |               |              |                    |      |                |                 | (6)                           |                    |              |                         |         |
| CD74AC652M       | ACTIVE        | SOIC         | DW                 | 24   | 25             | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | AC652M                  | Samples |
| CD74AC652M96     | ACTIVE        | SOIC         | DW                 | 24   | 2000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | AC652M                  | Samples |
| CD74ACT652M      | ACTIVE        | SOIC         | DW                 | 24   | 25             | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | ACT652M                 | Samples |
| CD74ACT652M96    | ACTIVE        | SOIC         | DW                 | 24   | 2000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | ACT652M                 | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| CD74AC652M96                | SOIC            | DW                 | 24 | 2000 | 330.0                    | 24.4                     | 10.75      | 15.7       | 2.7        | 12.0       | 24.0      | Q1               |
| CD74ACT652M96               | SOIC            | DW                 | 24 | 2000 | 330.0                    | 24.4                     | 10.75      | 15.7       | 2.7        | 12.0       | 24.0      | Q1               |



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# PACKAGE MATERIALS INFORMATION

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\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74AC652M96  | SOIC         | DW              | 24   | 2000 | 350.0       | 350.0      | 43.0        |
| CD74ACT652M96 | SOIC         | DW              | 24   | 2000 | 350.0       | 350.0      | 43.0        |



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#### TUBE



#### \*All dimensions are nominal

| Device      | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74AC652M  | DW           | SOIC         | 24   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| CD74ACT652M | DW           | SOIC         | 24   | 25  | 506.98 | 12.7   | 4826   | 6.6    |

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